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Docket No. 5833-A-13

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Washington, D.C. 20231.

Marvin A. Glazer

January 22, 2001

Date

Box PATENT APPLICATION Honorable Commissioner for Patents Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application of

Inventors:

Jamin Ling and Dave Charles Stepniak

For:

"ELECTROLESS Ni/Pd/Au METALLIZATION STRUCTURE FOR COPPER

INTERCONNECT SUBSTRATE AND METHOD THEREFOR"

Enclosed are:

X 1 sheet of informal drawings

X Declaration and Power of Attorney

X Specification (incl. claims and abstract) 13 pages.

- X Assignment
- X Form PTO-1595 Recordation Form Cover Sheet

## **CLAIMS AS FILED**

Total Claims	24	- 20 =	4	_ x \$18.00 = _	\$ 72.00
Independent Claims	2	3 =	0	x \$80.00 = _	-0-
				Basic Fee: _	\$710.00

X The Commissioner is hereby authorized to charge any additional fees which may be required by this paper to Deposit Account No. 03-0088 and to credit any overpayment to this Deposit Account. Two (2) duplicate copies of this sheet are enclosed.

Total Filing Fee: \$782.00

X A check in the amount of \$822.00 to cover the filing fee and the recordation fee (if needed) is enclosed.

Marvin A. Glazer Reg. No. 28,801